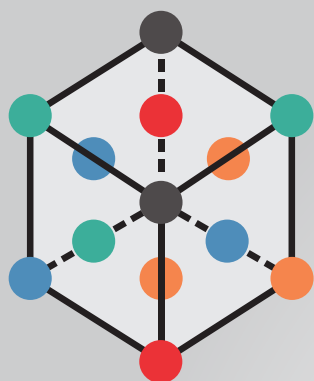


# CALL FOR ABSTRACTS

SUBMISSION DEADLINE: APRIL 15, 2019



WORLD CONGRESS ON  
**HIGH ENTROPY ALLOYS**  
**HEA2019**

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The World Congress on High Entropy Alloys (HEA 2019) is a new, cross-disciplinary technical forum designed to share the latest research advances in materials with high configurational entropy, including both single-phase and multiphase (compositionally complex) alloys.

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